





KU163C

Features

Function	Reflector Sensor (Analog Output)		
Product features	 Outer Dimension: 3.1 x 1.9 x 1.1mm (LxWxH) Compact Small Package of Surface Mount Integrated IRED and Phototransistor Lead-free soldering compatible RoHS compliant 		
Die materials (Emitter)	GaAs		
Die materials (Detector)	Si		
Assembly method	Auto pick & place machine (Auto Mounter)		
Soldering methods	Reflow soldering, and manual soldering XPlease refer to Soldering Conditions about soldering.		
Taping and reel	2,500pcs per reel in a 8mm width tape. (Standard) Reel diameter: ϕ 180mm		

Recommended Applications

- •Cameras, DSC (Lenz Controller, Film Detection, Tape-end Detection)
- •MO, DVD (Pick-up Controller, Disk Detection)
- •Other General Applications for Controller (Object Detection, Code Reader)





Absolute Maximum Ratings

Item		Symbol	Absolute Maximum Ratings	Unit
Operating Temperature		T _{opr}	-30~+85	င
Storage Temperature		T _{stg}	-40~+100	င
Power Dissipation		Pd	75	mW
	Forward Current	I _F	20	mA
LED	Derating ^{※1}	⊿I _F	0.17	mA/℃
Ta = 25℃ Puls	Pulse Forward Current **2	I _{FRM}	300	mA
	Pulse Forward Current Derating **1	⊿ I _{FRM}	4	mA/℃
	Reverse Voltage	V_R	5	V
Collector Dissipation		Pc	75	mW
Phototransistor	Collector-Emitter Voltage	V _{CEO}	20	V
Ta = 25°C	Emitter-Collector Voltage	V _{ECO}	5	V
	Collector Current	lc	20	mA

[※]1 Ta=25℃ or higher

 $[\]mbox{\%}\,2\,$ I_{FRM} Measurement condition : Pulse Width $\mbox{$\leq$}$ 0.1ms, Duty $\mbox{$\leq$}$ 1/100





Electro-Optical Characteristics

(Ta=25℃)

Item Conditions							
		Conditions	Symbol	Characteristics		Unit	
	Forward Voltage	I _F = 5mA	V _F	MIN.	0.9		
				TYP.	1.1	v	
Input				MAX.	1.5		
	Reverse Current	$V_R = 5V$	I _R	MAX.	10	μΑ	
	Peak Wavelength	$I_F = 20 \text{mA}$	λ,	TYP.	940	nm	
Output	Dark Current	$V_{CEO} = 10V$	I _{CEO}	MAX.	0.1	μΑ	
Output	Peak Sensitivity Wavelength	-	λp	TYP.	850	nm	
	Photo Current	$V_{CE} = 5V$,		MIN.	115	μΑ	
		$I_F = 5mA$,	lc	TYP.	200		
		d = 1mm	MAX.	425			
	Leak Current	$V_{CE} = 5V$,					
Coupling Characteristics		$I_F = 5mA$,	I _{LEAK}	MAX.	2	μΑ	
Characteristics		No Reflector					
	Rise Time/Fall Time	V _{CE} = 10V,					
		$R_L = 100\Omega$,	tr/tf	TYP.	10/10	μs	
		$I_F = 5mA$					

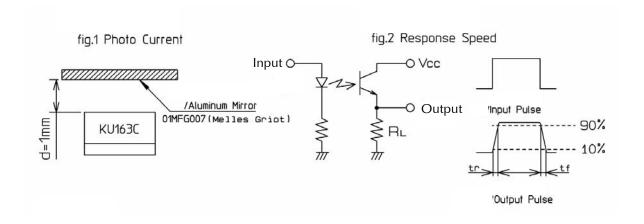




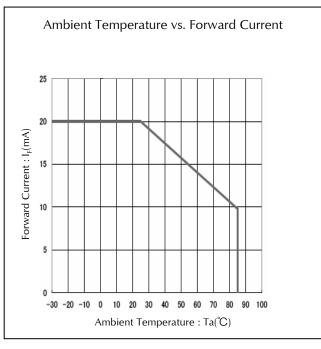


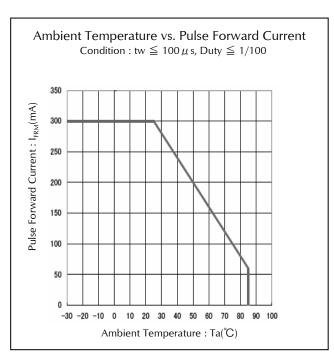
Photo Current Rank

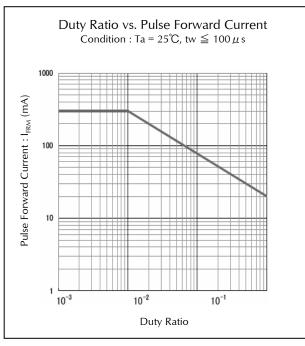
Ranks	Photo Curre	Conditions	
Kanks	MIN.	MAX.	Conditions
В	115	162	
С	146	206	Ir=5mA
D	185	262	I _F =5mA V _{CE} =5V d=1mm
E	236	334	d=1mm
F	300	425	

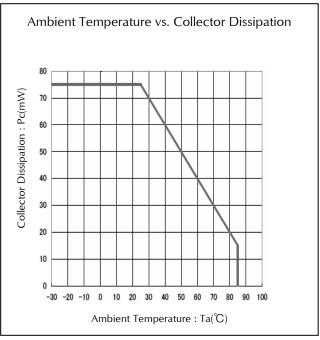






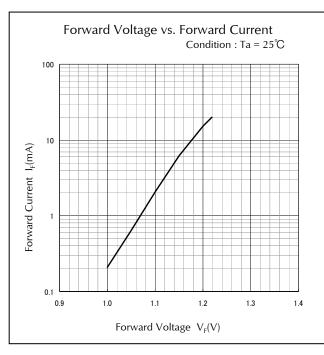


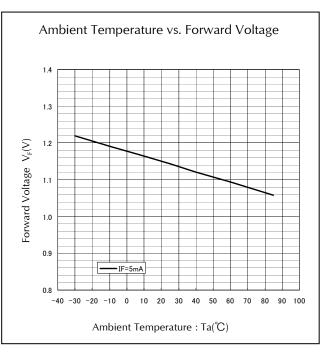


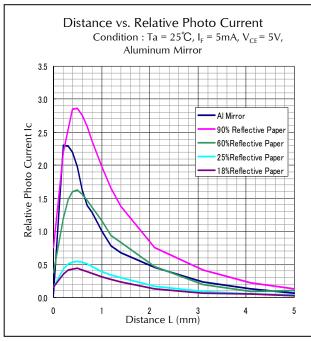


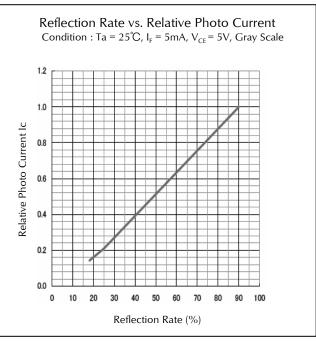






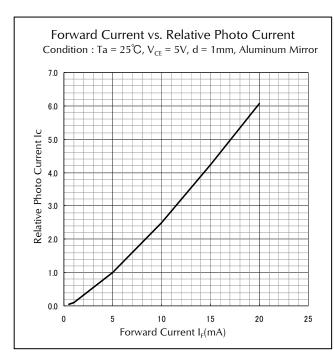


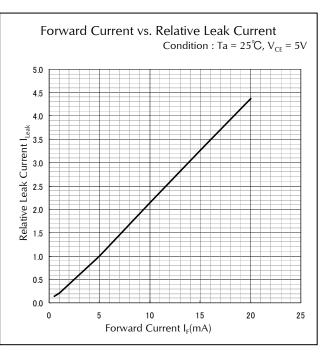


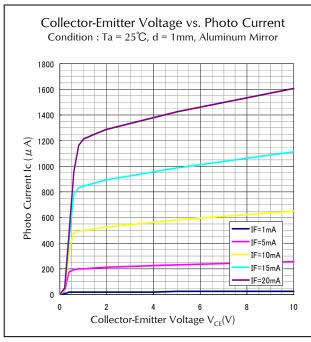


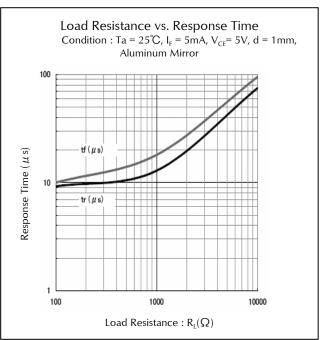






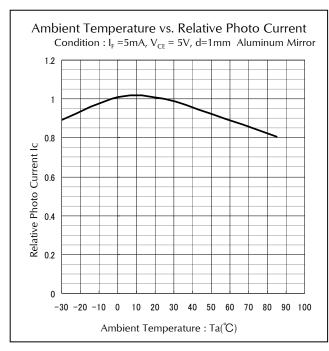


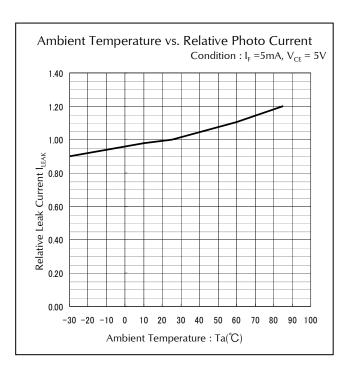


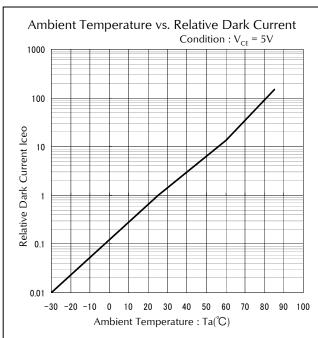






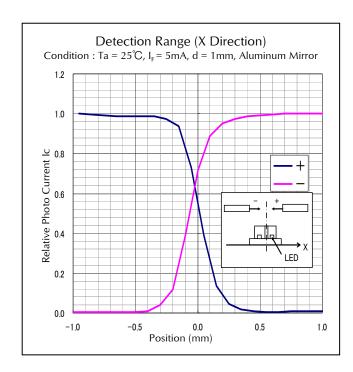


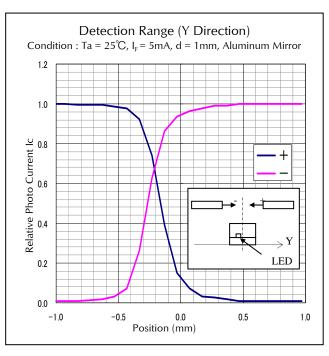












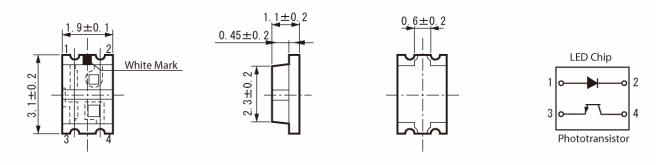




Package Dimensions

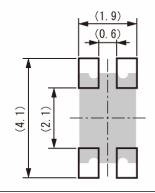
(Unit: mm)

MASS: (9.0mg)



Recommended Soldering Pattern

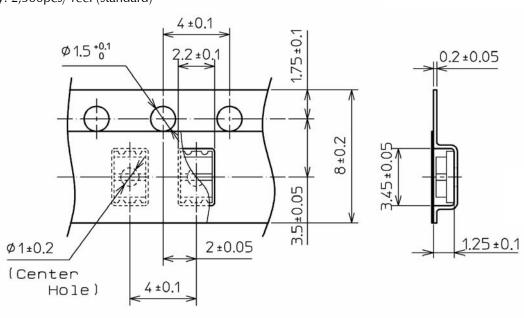
(Unit: mm)



Taping Specification

(Unit: mm)

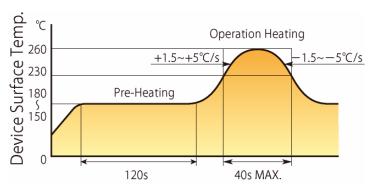
Quantity: 2,500pcs/ reel (standard)







Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the product resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the product from absorbing moisture.
- 3) Temperature fluctuation to the product during the pre-heating process shall be minimized.

Manual Soldering Conditions

(1) Please avoid the installation of the substrate with the manual soldering as much as possible. If you do with the manual soldering, please note the following.

Iron tip temp.	350 ℃	
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.) (Per One Terminal)





Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25° C, LED : I _F = 5mA, Phototransistor : V _{CE} = 5V, There is a reflector., d = 1mm	1,000 h	0/25
Wet High Temp. Operaing Life	EIAJ ED- 4701/100(102)	Ta = 60° C, RH = 90%, LED : I _F = 5mA, Phototransistor : V _{CE} = 5V, There is a reflector., d = 1mm	1,000 h	0/25
High Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 85° C, LED : I_F = 5 mA, Phototransistor : V_{CE} = $5V$, There is a reflector., $d = 1$ mm	1,000 h	0/25
Low Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = -30 °C, LED : I_F = 5mA, Phototransistor : V_{CE} = 5V, There is a reflector., d = 1mm	1,000 h	0/25
Thermal Shock	EIAJ ED- 4701/200/(203)	-40°C(15min)∼100°C(15min)	5 cycles	0/25
Resistance to Soldering Heat	EIAJ ED- 4701/300(301)	(Reflow)Preheat: 150~180℃(120s Max.) Operating Heat: 230℃以上 (40s Max.) Peak: 260℃ (5s Max.)	Twice	0/25

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Forward Voltage	VF	IF=5mA	Testing Max.Value ≧ Initial Value x 1.2
Reverse Current	IR	V _R =5V	Testing Max.Value $\geq 10 \mu\text{A}\text{x}2.5$
Photo Current	lc	I⊧=5mA, V _{CE} =5V, d=1mm	Testing Max.Value ≧ Initial Value × 1.2 Testing Min.Value ≦ Initial Value × 0.8
Leak Current	I _{LEAK}	IF=5mA, V _{CE} =5V, No Reflector	Testing Max.Value $\geq 2 \mu \text{ A x 1.2}$





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